

Title (en)

STRUCTURE FORMING METHOD, APPARATUS AND PRODUCT

Title (de)

STRUKTURHERSTELLUNGSMETHODE, VORRICHTUNG HIERFÜR UND PRODUKT

Title (fr)

PROCEDE, APPAREIL ET PRODUIT DE FORMATION D'UNE STRUCTURE

Publication

**EP 1147263 A1 20011024 (EN)**

Application

**EP 99951516 A 19990920**

Priority

- US 9921675 W 19990920
- US 9823034 W 19981030

Abstract (en)

[origin: WO0026478A1] A method of forming a continuous composite structure includes encapsulating solid additive particles in a first reactive resin forming material and migrating part of the mixture through the porous blanket to form a coated matrix/blanket (59). A thin coating of a second preselected resin forming material which substantially cures immediately upon application is applied over one major adhesive upper surface of the matrix/blanket (59) while allowing an area (72) of adhesive surface to remain exposed along one edge of the upper surface of the matrix/blanket (59). A plurality of preselected flexible lengths of the coated matrix/blanket (59) are individually positioned successively in an overlapping orientation with the exposed adhesive area (72) of the upper surface of the adjoining positioned length tightly affixed to the adhesive lower surface of the succeeding length to form a continuous composite structure.

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